## SURFACE MOUNT SILICON HIGH CURRENT SCHOTTKY DIODE



www.centralsemi.com

## **DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMDSH2-3 is a silicon Schottky diode, manufactured in a SOD-323 surface mount package, designed for applications requiring a low forward voltage drop.

**MARKING CODE: S2** 



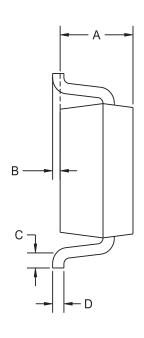
SOD-323 CASE

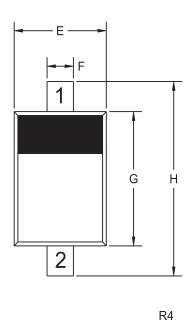
Peak Repetiti Continuous F Peak Forward Power Dissip		SYMBOL VRRM IF IFSM PD	30 20 1. 25	00 0 50	UNITS V mA A mW
Operating and Thermal Resi	d Storage Junction Temperature stance	T <sub>J</sub> , T <sub>stg</sub> ΘJΑ	-65 to 50		°C/W
ELECTRICAL SYMBOL	L CHARACTERISTICS: (T <sub>A</sub> =25°C) TEST CONDITIONS V <sub>R</sub> =30V	MIN	<b>TYP</b> 19	<b>MAX</b> 50	<b>UNITS</b> μΑ
BVR	I <sub>R</sub> =100μA	30			V
$V_{F}$	I <sub>F</sub> =2.0mA		0.186		V
V <sub>F</sub>	I <sub>F</sub> =15mA		0.245		V
VF	I <sub>F</sub> =100mA		0.35		V
$V_{F}$	I <sub>F</sub> =200mA		0.42	0.55	V
$C_{J}$	$V_R$ =10V, f=1.0MHz		6.0		pF

# SURFACE MOUNT SILICON HIGH CURRENT SCHOTTKY DIODE



## **SOD-323 CASE - MECHANICAL OUTLINE**





## LEAD CODE:

- 1) Cathode
- 2) Anode

MARKING CODE: S2

DIMENSIONS								
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
Α	0.031	0.039	0.80	1.00				
В	0.000	0.004	0.00	0.10				
С	0.008	-	0.20	-				
D	0.004	0.007	0.11	0.19				
Е	0.045	0.053	1.15	1.35				
F	-	0.014	-	0.35				
G	0.063	0.071	1.60	1.80				
Н	0.094	0.102	2.40	2.60				
00D 000 (DEV D4)								

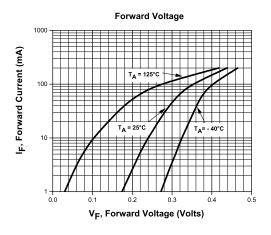
SOD-323 (REV: R4)

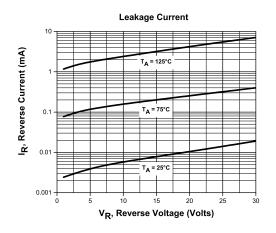
R4 (13-November 2015)

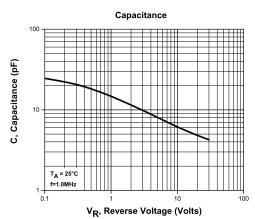


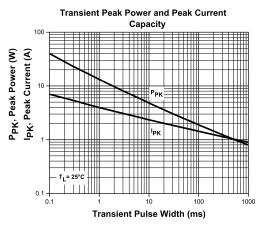


### TYPICAL ELECTRICAL CHARACTERISTICS





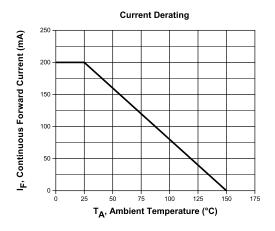


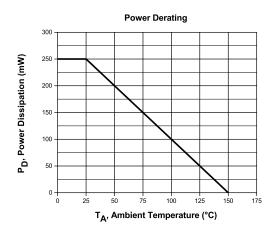






### TYPICAL ELECTRICAL CHARACTERISTICS





#### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

#### Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA

Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

**Worldwide Distributors:** 

www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: <a href="https://www.centralsemi.com/terms">www.centralsemi.com/terms</a>

www.centralsemi.com (001)